

Attorney Docket No. 36856.1178

## **DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint

inventor (if plural names are lis sought on the invention entitled PIEZOELECTRIC COMPONE checked:	METHOD OF PRODUCIN	IG PIEZOELECTRIC COMP	ONENT A	ND		
x was filed on <u>December</u> Application Number <u>10/728</u>		ited States Application Numbs amended on		International		
I hereby state that I have review including the claims, as amend	wed and understand the co ed by any amendment refe	ntents of the above identified red to above.	d specificat	tion,		
I acknowledge the duty to discl	ose information which is ma	aterial to patentability as defi	ned in 37 (	CFR § 1.56.		
I hereby claim foreign priority be for patent or inventor's certificatione country other than the Unit for patent or inventor's certification on which priority is	te, or § 365(a) of any PCT ed States, listed below and le, or PCT International ap	International application which I have also identified below a	ch designa inv foreign	ted at least		
Prior Foreign Application(s)		Priority Date	Priority Claimed			
2002-354712	Japan	December 6, 2002	Yes	No		
(Number)	(Country) (PCT)	(Day/Month/Year Filed)				
2003-378190	Japan	November 7, 2003	Yes	No		
(Number)	(Country) (PCT)	(Day/Month/Year Filed)				
I hereby claim the benefit under below.	35 U.S.C. § 119(e) of any	United States provisional ap	plication(s	) listed		
(Application Number)		(Filing Date)				
(Application Number)		(Filing Date)				

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

(Application Numbe	r)	(Filing Date)		(Status – patented, pending, abandoned)		
(Application Number	r)	(Filing Date)		(Status – patented, pending, abandoned)		
I hereby appoint the business in the Pate	following attorrent and Tradema	ney(s) and/or agent( ark Office connected	(s) to prosecute the distribution to the distribution of the distr	nis applica	tion and to tra	ansact all
Joseph R. Keating, I Christopher A. Benn	Reg. No. 37,368 ett, Reg. No. 46	3 5,710				
Address all correspo	endence to:	Keating & Bennett 10400 Eaton Plac Fairfax, VA 22030 (703) 385-5200	e, Suite 312			÷ .
I hereby declare that on information and b knowledge that willfu under Section 1001 of jeopardize the validit	il false statement of Title 18 of the	nts and the like so not United States	irther that these s nade are punisha le and that such v	statements	were made v	with the
Full name of first inve	entor (given nar	ne, family name)	Masato HIGUCH	11		
Inventor's signature	masi	ato Higuchi		Date	april	8. 2004
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Full name of second i	inventor (given	name, family	Nobushige AR	RAKI		
Inventor's signature Residence <b>Kan</b> aza		bushige ar	ahi	Date	April	13. 2004
Post Office Address		wa-ken, Japan Manufacturing Co.,	Ltd., 26-10, Tenji	in 2-chome	_ Citizenship e, Nagaokaky	
Full name of third inve	entor (given nan	ne, family name)	Hideki SHINKAI			
nventor's signature		i Shinkai		Date	April s	200%
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